

Facility Modifications & Preparation (FMP)

Requirements and Design Breakout Presentation NSF Review of Advanced LIGO Project

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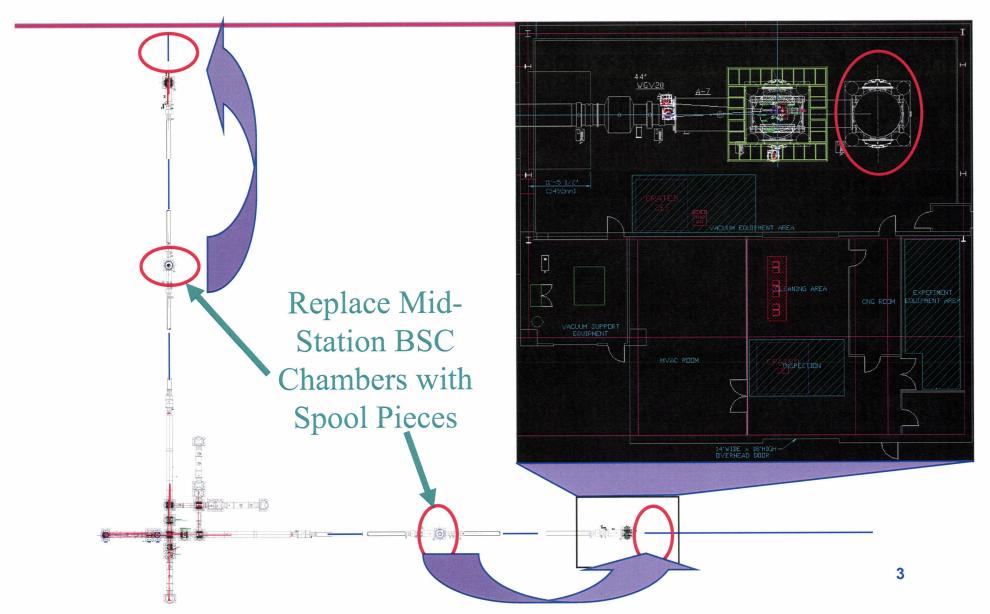
advancedligo FMP Functions



- Design & Build Vacuum System Modifications \$2.80M, WBS .4
 - » Convert 2 km at Hanford Observatory to 4 km
 - » Move HAM Chambers for Input Optics (IO) and Interferometer Sensing & Control (ISC) use
 - » Does not include installation (INS WBS scope)
- Prepare the facilities (buildings, laboratories): \$3.98M, WBS .2.1, .3, .5
 - » Clean/modify spaces for use as clean assembly areas
 - » Refurbish large, portable, soft-walled, clean rooms
 - » Procure additional large, portable, soft-walled, clean rooms
 - » Procure additional vacuum bake ovens
 - » Prepare clean & conditioned spaces for storage
 - » Does not include assembly (subsystem WBS scope)
- Prepare for assembly and installation tasks: \$1.62M, WBS .1, .2.2, .2.3, .2.4
 - » Purchase additional material handling equipment, installation fixtures, optics lab supplies, clean room supplies, etc.
 - » Purchase supplies for wrapping, palletizing, storing assembled components
 - » Stage completed assemblies
 - » Plan the installation task (INS WBS only executes plan)
 - » Does not include installation (INS WBS scope) or system/subsystem test/acceptance (PM/systems WBS scope)

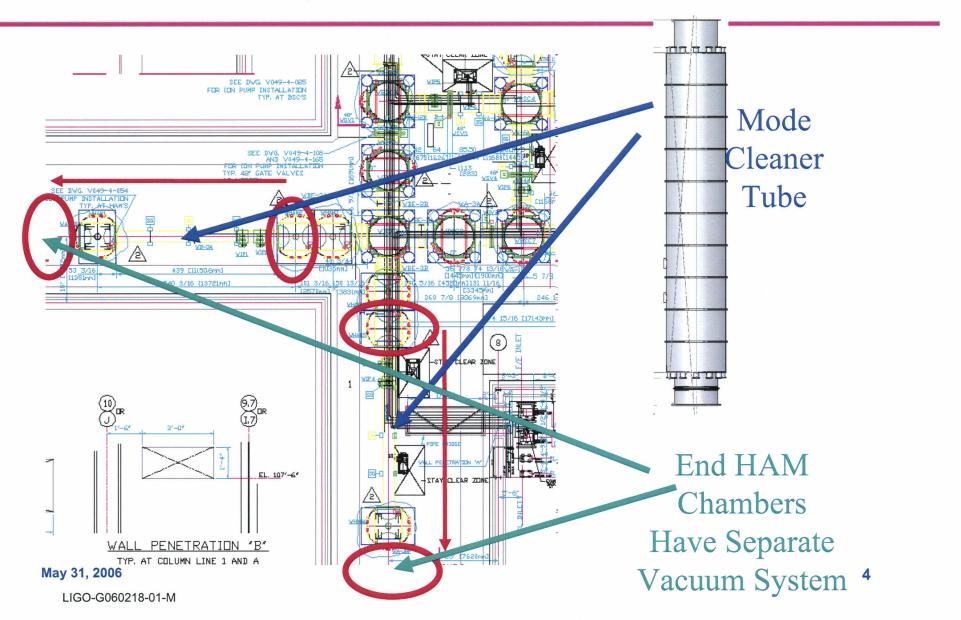


Mid-Station BSC Chamber relocated to End-Station





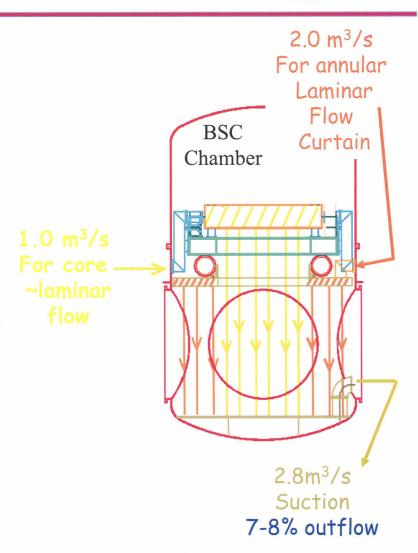
ISC Read-out Tables in Vacuum & Larger Input & Output Mode Cleaner Tubes





Ultra-High Vacuum (UHV) Preparation & Cleanliness

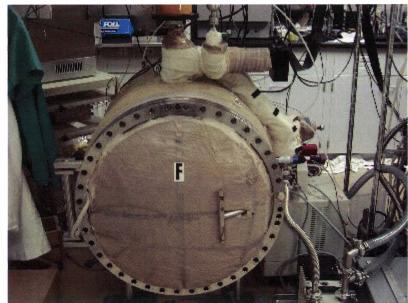
- Particulate Cleanliness Requirements are more stringent than for initial LIGO
 - » Particulate cleaning: lonized, particulate free airflow over benches are planned
 - » Basic Paradigm: The optical surfaces are only exposed when absolutely necessary
 - » LIGO Lab spaces plus Class 100, softwalled clean rooms erected within are adequate
 - » Plan to add laminar air shower into the Test Mass (BSC) Chambers





Ultra-High Vacuum (UHV) Preparation & Cleanliness

- Low-Volatile Residue (out-gassing) Cleanliness
 Requirements are the same as for initial LIGO
 - » Same clean and bake (air or vacuum) procedures/protocols as used for Initial LIGO
 - » Added Vacuum Bake Oven Capacity needed to support assembly schedule



Vacuum Bake Oven at Caltech



On-site vs. Off-site Assembly

- Limited space and limited availability of observatory staff during science runs for assembly
- Perform assembly tasks which do not need to be done at the observatory at CIT, MIT, UFL, ... or the other observatory
 - » Rather limited space available at CIT, MIT especially clean room space (but not insignificant)
 - » Possible tasks to be performed off-site:
 - HEPI pier assembly
 - Electronics module stuffing, testing
 - Electronics rack, crate assembly
 - Optical lever modules
 - AOS telescope assembly
- Out-Sourced Assembly
 - » Cleaning & Assembly of the Internal Seismic Isolation (ISI) system may be out-sourced to Fabricator
 - » Virtually all board-level Electronics Assembly is out-sourced exploring out-sourcing of box-level assembly & board/unit test

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Assembly Spaces

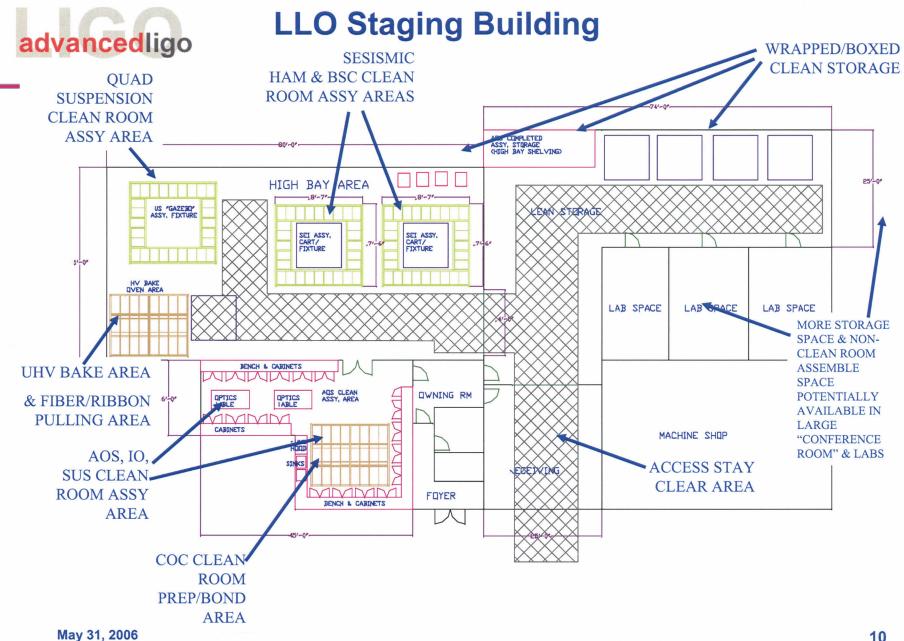
- Have defined a possible assembly scenario & identified subsystem assembly space needs
- Hanford
 - » Convert staging building high bay into clean space
 - » Staging Building supports staging & assembly for:
 - Internal Seismic Isolation (ISI) for HAM Chamber
 - Internal Seismic Isolation (ISI) for BSC Chamber
 - Suspension Quadruple Pendulum
 - Suspension Triple Pendulum
 - » Lab Support Building:
 - Fused Silica Ribbon/Fiber Pulling (for SUSpensions)
 - Vacuum Baking
 - Ear Bonding to Core Optics Components (COC)
 - » Operations Support Building:
 - Laser Lab
 - Input Optics Assembly
 - Thermal Compensation System Assembly
 - Auxiliary Optics Subsystem Assembly
 - Vacuum Baking
 - » Mechanical Room (Vertex Building)



Assembly Spaces (continued)

Livingston

- » Convert staging building high bay into clean space
- » Staging Building supports staging & assembly for:
 - Internal Seismic Isolation (ISI) for HAM Chamber
 - Internal Seismic Isolation (ISI) for BSC Chamber
 - Suspension Quadruple Pendulum
 - Suspension Triple Pendulum
 - Fused Silica Ribbon/Fiber Pulling (for SUSpensions)
 - Vacuum Baking
 - Ear Bonding to Core Optics Components (COC)
- » Operations Support Building:
 - Laser Lab
 - Input Optics Assembly
 - Thermal Compensation System Assembly
 - Auxiliary Optics Subsystem Assembly
 - Vacuum Baking
- If required for large assembly part storage, we'll rent space in town to buffer deliveries (have contingency to cover costs)

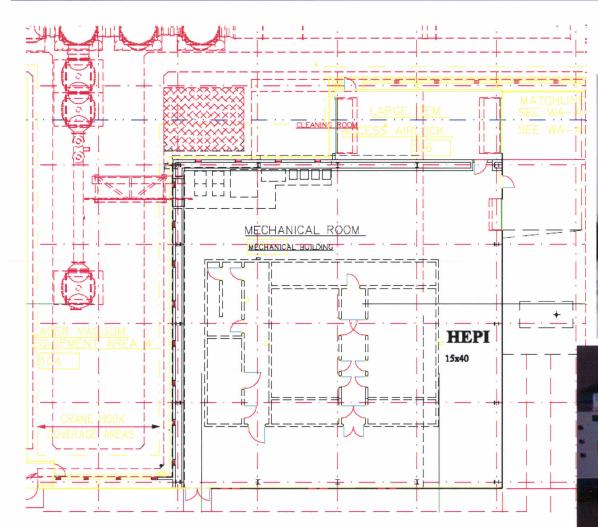


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HEPI Assembly Space





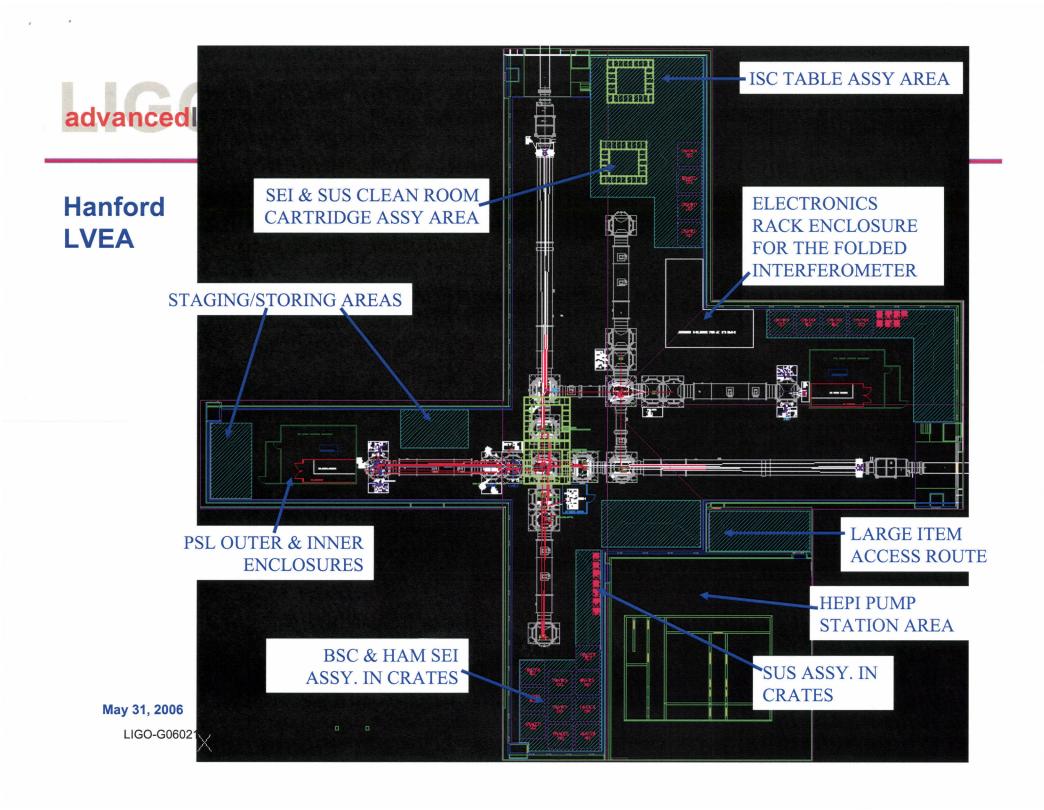
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LVEA/VEA STORAGE & STAGING AREAS

- Subsystem post-assembly, long-term, storage and installation staging areas are in the Laser/Vacuum Equipment Area (LVEA)
 - » Adequate for LLO
 - » At LHO, also need to erect clean space inside existing warehouse
 - » Access is through the large item access route (or the main corner station receiving/cleaning areas)
- Access during Science Runs is restricted to brief periods
 - » Only a few hours per month is needed to transport finished assemblies into the Laser/Vacuum Equipment Area (LVEA)
 - » Sufficient temporary storage is available in the staging building in the interim periods





FMP development status

- Subsystem assembly space & facility requirements
 - » Initial estimates received
 - » need to definitize & update as prototypes are built leads to written Assembly Plan with coordination of common space use
- Vacuum Modifications
 - » Review & refine conceptual design once optical layout has passed Preliminary Design Review (ADL Systems)
- Cleanliness Requirements
 - » Particulate cleanliness requirements need to be firmed up, especially with regard to in-situ environment
 - » Driven by low optic scattering requirements on-going studies by COC subsystem
 - » Concept for improved air flow/cleanliness in the chambers to be designed



Development work plan, challenges

- Maintaining Particulate Cleanliness
- Handling the Simultaneous Assembly Tasks and Space Needs will be Challenging
- Utilizing Available Space for Storage will also be challenging